SPECIFICATION FOR APPROVAL

客戶 / CUSTOMER:				
日期 / DATE:				
品名 / PART NAME: <u>陶 瓷 谐 振 器</u>				
規格 / DESCRIPT:7234 4.00MHz				
佑田料號 / OUR PART NO:CRCB04M00T530RO				
客戶料號 / CUSTOMER PART NO				
本承認書一式()份,請簽回一份。				

	工程	品 管	審 核
UTI			
CUSTOMER			

佑田电子科技有限公司

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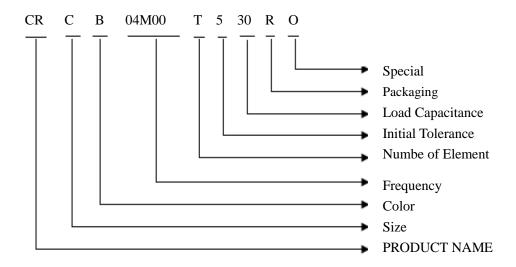
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1. Scope

This specification is applied to the ceramic resonator in IC oscillation circuit

2. PART NUMBER



3. ELECTRICAL CHARACTERISTICS

The MHZ ceramic resonator must meet the following performance when tested in the circuit indicated in figure 1 and figure 2.

Measuring condition:temperature($+15\sim35^{\circ}$ C),Humidity($45\sim85\%$ RH)

ITEM	SPECIFICATION
Oscillation	4.00MHz
Initial Tolerance	Within $\pm 0.5\%$
Resonant Impedance	30 Ω Max.
Built-in Load Capacitance	$30\mathrm{PF}~\pm~20\%$ max.
Insulation Resistance	$100 M\Omega$ min (apploed D. C. IOV)
Withstanding Voltage	D.C 100V, 5seconds max
Rated Working Voltage	D. C. 6V
(1)D.C .Voltage	15Vp-p
(2)A.C.Voltage	
Temperature Stability	\pm 0.3% max. (from initial value)
. Operating Temperature	-20°C~+80°C
. Storage Temperature	-40°C ~+85°C
Aging(10years)	\pm 0.1% max. (from initial value)

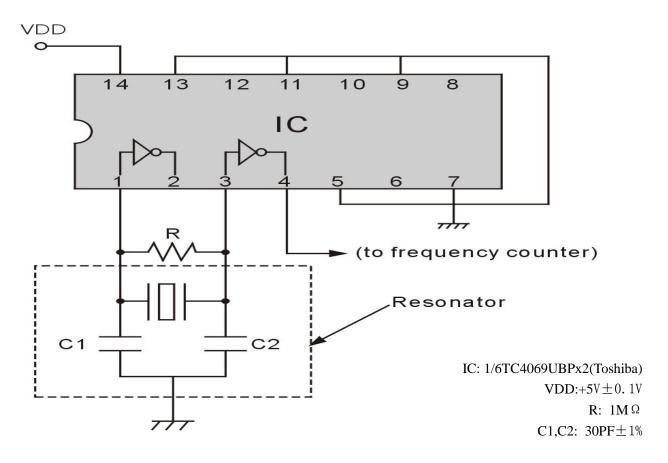


Figure 1. Test Circuit for Oscillating Frequency

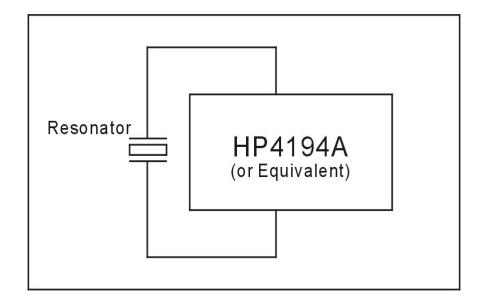
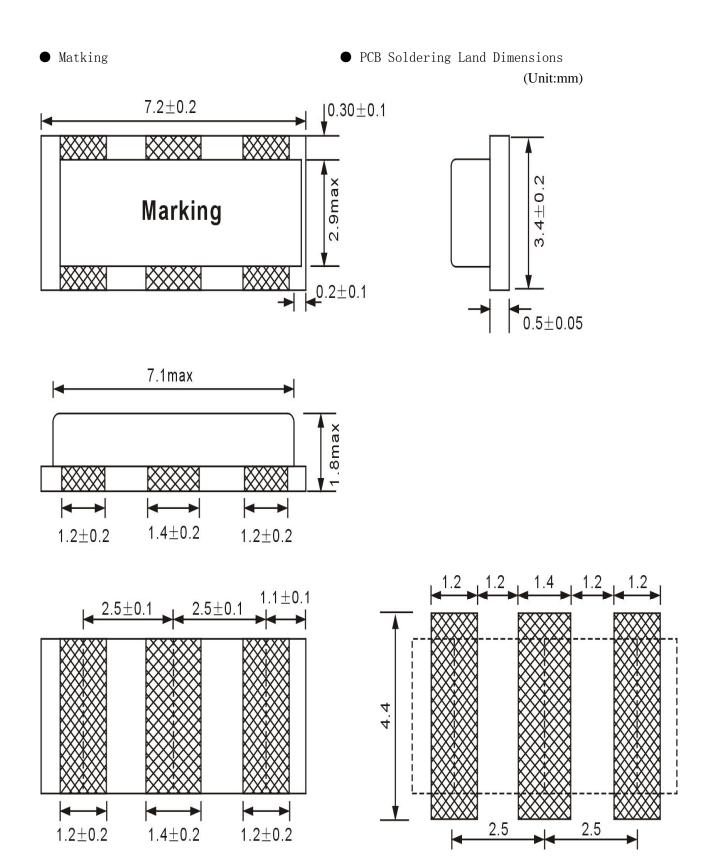


Figure 2. Measurement for Resonant Impedance

4. DIMENSIONS & STRUCTURE



5.ENVIRONEMNTAL & PHYSICAL CHARACTERISTICS

ITEM	CONDITION & REQUIREMENT	
5-1.	After being placed in a chamber with +85 $\pm 2^{\circ}$ C for 500 hours and then being placed in	
Storage in Hihg Temp	natural condition for 1 hour, then measure.	
6 F	→ To be satisfied Table 1.	
5-2.	After being placed in a chamber with $-55\pm3^{\circ}$ °C for 500 hours and then being placed in	
Storage in low Temp.	natural condition for 2 hour, then measure.	
storage in 10 to 10 inp.	→ To be satisfied Table 1.	
5-3.	After being placed in a chamber within +90 to 95% R.H. at +60 $\pm 2^{\circ}$ C for 500 hours and	
Humidity	then being placed in a chamber within +50 to 55% K.H. at +60 ±2 € for 500 hours and then being placed in natural condition for 2 hour, then measure.	
Trainiaity	To be satisfied Table 1.	
5-4.	After being kept at room temperature, the resonator shall be placed at temperature of -55°C.	
Heat Shock	After 30 minutes at this temperature resonator shall be immediately placed at temperature of	
Treat Shock	+85°C. After 30 minutes at this temperature resonator shall be returned to -55°C again .After	
	five above cycles, the resonator shall be returned to room temperature for at least 1 hour,	
	then measure.	
	→ To be satisfied Table 1.	
5-5.	Resonator shall be measured after 3 times random drops from the heigh of 1 m on wooden	
Random Drop		
Kandom Drop	floor. →No visible damage and the measured values shall meet Table 1.	
5-6.	Resonator shall be measured after being applied vibration of amplitude to 1.5mm with 10 to	
Vibration Test	55Hz band of vibration frequency to each of a perpendicular directions for 2 hours.	
violation lest	No visible damage and the measured values shall meet Table 1.	
5-7.	Resonator is soldered onto the center of PCB which is laid on the 2 small supporters spaced	
Bending strength PCB	90mm. PCB deflected to 3mm below from horizontal level by the pressing force with 20x10.	
Dending suchgui I CD	R10 stick. The force is supplied for 1 second, 5 times repeatedly.	
	Velocity of pole for press: 0.5mm/sec.	
	velocity of pole for press. 0.5mm/sec.	
	1 00×40 D40 00×1	
	20×10.R10.Stick	
	·	
	1.0	
	<u> </u>	
	Deflection	
	45 45	
	i	
	Unit: mm	
	→No visible damage and the measured values shall meet Table 1.	

ITEM	CONDITION & REQUIREMENT		
5-8.	End terminals are immersed in rosin for 5 seconds and then immersed in soldening bath of		
Solderability	$230\pm\ 5^{\circ}\text{C}$ for $3\pm\ 0.5$ seconds.		
	→75% min . End terminals shall be wet with solder.		
5-9.			
Resistance to Soldering			
Heat			
(1) D G			
(1) Reflow	Following profile of heat stress is applied to resonator, then being place in natural condition		
	for 1 hour, resonator shall be measured.		
	溫度 <u>Temperatrure(℃)</u>		
	Peak Temperature 240℃ max.		
	250 Peak Temperature 240 C max.		
	200 Preheating Gradual Cooling (in air)		
	(iii aii)		
	150		
	100		
	20sec. max.		
	30sec. min. 60~120sec. 120sec. max.		
	1. Preheating conditions shall be 140 to 160°C for 60 to 120 seconds. Ascending time		
	up to 150°C shall be longer than 30 seconds.		
	2. Heating conditions shall be within 20 seconds at 230°C min, but peak temperature		
	shall be lower than 240° C.		
(2) Soldering Iron	Soldering iron of $270 \pm 5^{\circ}\text{C}$ shall be placed 0.5mm above from electrode of		
(2) Soldering from	resonator. Melting solder through soldering iron shall be applied to electrode for 3 ± 1		
	seconds, then being place in natrual condition for 24 hour, resonator shall		
	be measured.		
	→ The measured values shall meet Table 1.		

TABLE1

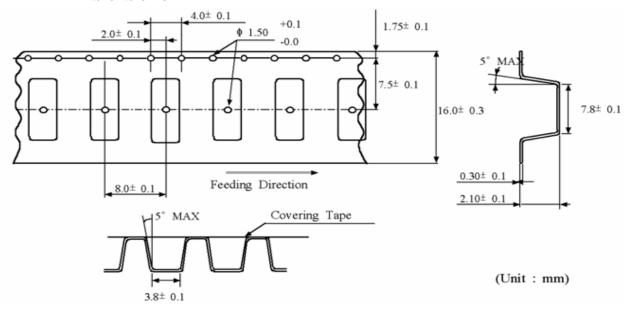
MEASUREMENTS	REQUIREMENTS	
Resonant Frequency	$\pm 0.1\%$ max. (from initial value)	

6.PACKAGING STANDARD

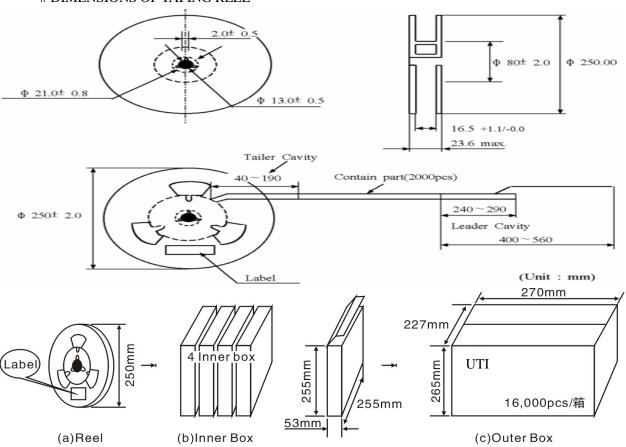
The products should be packaged for protecting form the accident which could be caused during transportation or preservation, and part name, quantity and inspection lot No, Shall be .given to the each minimum packing unit. The dimensions of carrier tape reper to the attached sheet.

Note) 1 Reel contains 2000 pcs Resonator.

DIMENSIONS OF CARRIER TAPE



DIMENSIONS OF TAPING REEL



7. CAUTIONS FOR USE.

- 7-1. Resonator might be damaged when an excess stress is applied.
- 7-2. Cleaning or washing of the component is not acceptable due to non sealed construction.

 Cleaning conditions, such as kinds of cleaning solvents, immersion time and temperatures etc, after soldering shall be checked by experiments before production.
- 7-3. Conformal coating of the component is acceptable. However ,the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.
- 7-4. Irregular or stop oscillation may occur under unmatched circuit conditions. And it shall be noted that oscillating frequencies of the ceramics Resonator may drift depending on IC applied (the type names, the manufacturer) and capacitance of external capacitors (C1,C2) and the circuit design in figure 1.

8. LIMITATION FOR USAGE

- 8-1. The component is manufactured and promoted to be used in general electronic of AV, home appliance, communication, measurement equipments and machine tools.
- 8-2. Contact us before using our products for the following applications.
 - 1)Aircraft equipment
 - 2)Aerospace equipment
 - 3)Undersea equipment
 - 4)Medical equipment
 - 5)Transportation equipment
 - 6) Traffic signal equipment
 - 7)Disaster prevention/Crime prevention equipmement
 - 8)Date-processing equipment
 - 9) Applications of similar complexity or with reliability requitements comparble to the applications listed in the above.

These applications requires especially high reliability in order to prevent defects which might directly cause damage to other party's life, body or property.

9.NOTICE

- 9-1. This specification mentions the quality of the component as a single unit .Insure the component is thoroughly evaluated in your application circuit.
- 9-2. Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by an abnormality or failure related to our product.
- 9-3. Please do not use this component in any application that deviates from its intended use as noted within the specification.
- 9-4.Return one of this specification after your signature of acceptance. In case of no return within three months from submission date, tis specification should be treated as accepted.